Subject index for papers in Volume 44

Each index entry below is accompanied by an author's name and a page number; the author index contains the title of the paper and the names of coauthors, if any.

Subject	Author	Page
Aerodynamics		
Approximate performance of periodic hypersonic cruise trajectories for global reach	Carter	703
Frequency response sensitivity functions for helicopter frequency domain system identification	Jones	748
Algorithms		
Applying recursion to serial and parallel *QR* factorization leads to better performance	Elmroth	605
Finite-element analysis of semiconductor devices: The FIELDAY program	Buturla	142
Minimal-storage high-performance Cholesky factorization via blocking and recursion	Gustavson	823
Alloys		
Characterization of constitutional liquid film migration in nickel-base alloy 718	Acoff	668
Nanosecond switching in thin magnetic films	Dietrich	167
Aluminum		
Reduction of electromigration in aluminum films by copper doping	Ames	89
Analytical models		
Finite-element analysis of semiconductor devices: The FIELDAY program	Buturla	142
Arithmetic and logical unit design		
A multithreaded PowerPC processor for commercial servers	Borkenhagen	885
POWER3: The next generation of PowerPC processors	O'Connell	873
Artificial intelligence		
Some studies in machine learning using the game of checkers	Samuel	206
ASICs		
Silicon:germanium-based mixed-signal technology for optimization of wired and wireless telecommunications	Meyerson	391
Atomic force microscopy (AFM)		
The "Millipede"—More than one thousand tips for future AFM storage	Vettiger	323
Biotechnology		
Metabolic effects on recombinant interferon-γ glycosylation in continuous culture of Chinese hamster ovary cells	Nyberg	770
Carrier transport in small structures		
Spatial variation of currents and fields due to localized scatterers in metallic conduction	Landauer	251
Checkers and chess		
Some studies in machine learning using the game of checkers	Samuel	206
Chemical vapor deposition		
Low-temperature Si and Si:Ge epitaxy by ultrahigh-vacuum/chemical vapor deposition: Process fundamentals	Meyerson	132
Chemistry and chemical engineering		
Chemical amplification resists: History and development within IBM	Ito	119
Circuit and device technology		
Custom circuit design as a driver of microprocessor performance	Allen	799
Design and characteristics of n-channel insulated-gate field-effect transistors	Critchlow	70

LSI yield modeling and process monitoring — Stapper — 112
Silicon:germanium-based mixed-signal technology for optimization of wired and wireless telecommunications — Meyerson — 391
The future of CMOS technology — Isaac — 369
The future of interconnection technology — Theis — 379

CMOS
Picosecond imaging circuit analysis — Tsang — 583
Silicon:germanium-based mixed-signal technology for optimization of wired and wireless telecommunications — Meyerson — 391
The future of CMOS technology — Isaac — 369

Codes and coding
Holographic data storage — Ashley — 341

Communication theory
Notes on the history of reversible computation — Bennett — 270

Communications and communication networks
Bandwidth problems in high-speed networks — Saroit Ismail — 919

Compilers and interpreters
The 801 minicomputer — Radin — 37

Computational methods
Applying recursion to serial and parallel *QR* factorization leads to better performance — Elmroth — 605
Minimal-storage high-performance Cholesky factorization via blocking and recursion — Gustavson — 823

Computer architecture
A multithreaded PowerPC processor for commercial servers — Borkenhagen — 885
POWER3: The next generation of PowerPC processors — O'Connell — 873
S/390 microprocessor design — Webb — 899
The 801 minicomputer — Radin — 37

Computer organization and design
A multithreaded PowerPC processor for commercial servers — Borkenhagen — 885
A performance methodology for commercial servers — Kunkel — 851
POWER3: The next generation of PowerPC processors — O'Connell — 873
S/390 microprocessor design — Webb — 899
The 801 minicomputer — Radin — 37

Computer-aided design
The evolution of RISC technology at IBM — Cocke — 48

Computers
Irreversibility and heat generation in the computing process — Landauer — 261

Control theory and systems
Stability of nonlinear polynomial ARMA models and their inverse — Hernández — 725

Controlled-collapse chip connection (C-4) technology
Controlled collapse reflow chip joining — Miller — 93

Copper
The future of interconnection technology — Theis — 379

Cryptography
Cryptography — Coppersmith — 246

Data transmission
Bandwidth problems in high-speed networks — Saroit Ismail — 919

Data, structures and accessing
Applying recursion to serial and parallel *QR* factorization leads to better performance — Elmroth — 605
Holographic data storage — Ashley — 341
Minimal-storage high-performance Cholesky factorization via blocking and recursion — Gustavson — 823
The future of magnetic data storage technology — Thompson — 311
The "Millipede"—More than one thousand tips for future AFM storage — Vettiger — 323

Design automation
LSS: A system for production logic synthesis — Darringer — 157

Device design
Custom circuit design as a driver of microprocessor performance — Allen — 799
The future of CMOS technology — Isaac — 369

Dielectrics
The future of CMOS technology — Isaac — 369

Digital computers
Some studies in machine learning using the game of checkers — Samuel — 206
The Random-Access Memory Accounting Machine: I. System organization of the IBM 305 — Lesser — 6
The Random-Access Memory Accounting Machine: II. The magnetic-disk, random-access memory — Noyes — 16

Display technology
An SXGA reflective liquid crystal projection light valve incorporating inversion by pixel bootstrapping — Schlig — 909
Electronic displays for information technology — Wisnieff — 409

Electrical conduction
Spatial variation of currents and fields due to localized scatterers in metallic conduction — Landauer — 251

Electron microscopy
Atomic resolution analytical microscopy — Batson — 477
Growth processes and phase transformations studied by *in situ* transmission electron microscopy — Ross — 489
Low-energy electron microscopy — Tromp — 503
Spin-polarized scanning electron microscopy — Allenspach — 553

Fabrication
Controlled collapse reflow chip joining — Miller — 93

Silicon:germanium-based mixed-signal technology for optimization of wired and wireless telecommunications — Meyerson 391
The future of CMOS technology — Isaac 369

Films
Application of rf discharges to sputtering — Koenig 106
Reduction of electromigration in aluminum films by copper doping — Ames 89

Films, epitaxy
Silicon:germanium-based mixed-signal technology for optimization of wired and wireless telecommunications — Meyerson 391

Films, magnetic
Magnetic thin films in recording technology — Dietrich 167
Nanosecond switching in thin magnetic films — Speriosu 186
Spin-polarized scanning electron microscopy — Allenspach 553

Films, semiconductor
Low-temperature Si and Si:Ge epitaxy by ultrahigh-vacuum/chemical vapor deposition: Process fundamentals — Meyerson 132
Silicon:germanium-based mixed-signal technology for optimization of wired and wireless telecommunications — Meyerson 391

Films, thin
Magnetic thin films in recording technology — Speriosu 186
Nanosecond switching in thin magnetic films — Dietrich 167

Game theory
Some studies in machine learning using the game of checkers — Samuel 206

Germanium
Silicon:germanium-based mixed-signal technology for optimization of wired and wireless telecommunications — Meyerson 391

Holography
Holographic data storage — Ashley 341

I/O devices, systems, and technology
An SXGA reflective liquid crystal projection light valve incorporating inversion by pixel bootstrapping — Schlig 909

IBM SAGE system
The Random-Access Memory Accounting Machine: II. The magnetic-disk, random-access memory — Noyes 16

IBM System/360
Architecture of the IBM System/360 — Amdahl 21
Solid Logic Technology: Versatile, high-performance microelectronics — Davis 56

IBM System/390 Parallel Enterprise Server
S/390 microprocessor design — Webb 899

IBM 305 (RAMAC)
The Random-Access Memory Accounting Machine: I. System organization of the IBM 305 — Lesser 6

IBM 350 (RAMAC)
The Random-Access Memory Accounting Machine: II. The magnetic-disk, random-access memory — Noyes 16

Image processing
Parallel image processing with the block data parallel architecture — Alexander 681
Scanning tunneling microscopy — Binnig 279

Imaging technology
Electronic displays for information technology — Wisnieff 409

Information technology
Electronic displays for information technology — Wisnieff 409

Instrumentation
The "Millipede"—More than one thousand tips for future AFM storage — Vettiger 323

Insulators
Application of rf discharges to sputtering — Koenig 106

Integrated circuit design
Custom circuit design as a driver of microprocessor performance — Allen 799

Integrated circuits
Picosecond imaging circuit analysis — Tsang 583
Solid Logic Technology: Versatile, high-performance microelectronics — Davis 56
The future of CMOS technology — Isaac 369
The future of interconnection technology — Theis 379

Interconnection technology
The future of interconnection technology — Theis 379

Lasers
Contributions of IBM to laser science—1960 to the present — Sorokin 294

Light
Holographic data storage — Ashley 341

Liquid crystals
An SXGA reflective liquid crystal projection light valve incorporating inversion by pixel bootstrapping — Schlig 909
Electronic displays for information technology — Wisnieff 409

Lithography
Chemical amplification resists: History and development within IBM — Ito 119
Low-energy electron microscopy — Tromp 503
The future of CMOS technology — Isaac 369

Logic design and technology
LSS: A system for production logic synthesis — Darringer 157
The future of CMOS technology — Isaac 369

Logic synthesis
LSS: A system for production logic synthesis — Darringer 157

Magnetic head-disk interaction
A high track-density servo-access system for magnetic recording disk storage — Hoagland 175

Magnetic recording
Magnetic thin films in recording technology — Speriosu 186

Magnetics—studies and structures
Nanosecond switching in thin magnetic films — Dietrich 167
The future of magnetic data storage technology — Thompson 311

Magnetoresistance
The future of magnetic data storage technology — Thompson 311

Materials
Medium-energy ion scattering for analysis of microelectronic materials — Copel 571
Scanning tunneling microscopy — Binnig 279
X-ray spectro-microscopy of complex materials and surfaces — Stöhr 535

Materials technology
Controlled collapse reflow chip joining — Miller 93
Holographic data storage — Ashley 341
Reduction of electromigration in aluminum films by copper doping — Ames 89

Mathematical functions and techniques
Applying recursion to serial and parallel *QR* factorization leads to better performance — Elmroth 605
Minimal-storage high-performance Cholesky factorization via blocking and recursion — Gustavson 823

Mathematics
Cryptography — Coppersmith 246

Mathematics (applied)
Ab initio computations in atoms and molecules — Clementi 228

Mechanical design
Scanning tunneling microscopy — Binnig 279

Medicine and medical electronics
A fuzzy linguistic model for the prediction of carpal tunnel syndrome risks in an occupational environment — McCauley Bell 759

Memory, random-access
The Random-Access Memory Accounting Machine: I. System organization of the IBM 305 — Lesser 6
The Random-Access Memory Accounting Machine: II. The magnetic-disk, random-access memory — Noyes 16

Mesoscopic phenomena
Spatial variation of currents and fields due to localized scatterers in metallic conduction — Landauer 251

Metallurgy
Characterization of constitutional liquid film migration in nickel-base alloy 718 — Acoff 668
Controlled collapse reflow chip joining — Miller 93
Reduction of electromigration in aluminum films by copper doping — Ames 89
The future of interconnection technology — Theis 379

Microelectronics
Atomic resolution analytical microscopy — Batson 477
Custom circuit design as a driver of microprocessor performance — Allen 799
Design and characteristics of n-channel insulated-gate field-effect transistors — Critchlow 70
Growth processes and phase transformations studied by *in situ* transmission electron microscopy — Ross 489
Low-energy electron microscopy — Tromp 503
Medium-energy ion scattering for analysis of microelectronic materials — Copel 571
Miniaturization of electronics and its limits — Keyes 84
Monolithic packaging concepts for high isolation in circuits and antennas — Drayton 715
Synchrotron X-ray scattering techniques for microelectronics-related materials studies — Jordan-Sweet 457

Micromachining
The "Millipede"—More than one thousand tips for future AFM storage — Vettiger 323

Microprocessor systems and applications
A multithreaded PowerPC processor for commercial servers — Borkenhagen 885
A performance methodology for commercial servers — Kunkel 851
Custom circuit design as a driver of microprocessor performance — Allen 799
Minimal-storage high-performance Cholesky factorization via blocking and recursion — Gustavson 823
POWER3: The next generation of PowerPC processors — O'Connell 873
S/390 microprocessor design — Webb 899

Models and modeling
A fuzzy linguistic model for the prediction of carpal tunnel syndrome risks in an occupational environment — McCauley Bell 759
A performance methodology for commercial servers — Kunkel 851
Approximate performance of periodic hypersonic cruise trajectories for global reach — Carter 703
Finite-element analysis of semiconductor devices: The FIELDAY program — Buturla 142
Frequency response sensitivity functions for helicopter frequency domain system identification — Jones 748
Stability of nonlinear polynomial ARMA models and their inverse — Hernández 725

Nanoscale structures and devices
The "Millipede"—More than one thousand tips for future AFM storage — Vettiger 323

Networks
Bandwidth problems in high-speed networks — Saroit Ismail 919

Optical interconnections
The future of interconnection technology — Theis 379

Optical lithography
Chemical amplification resists: History and development within IBM — Ito 119

Optical science and technology
Holographic data storage — Ashley 341

Optics
Holographic data storage — Ashley 341

Packaging
Monolithic packaging concepts for high isolation in circuits and antennas — Drayton 715
Solid Logic Technology: Versatile, high-performance microelectronics — Davis 56

Pattern recognition
Holographic data storage — Ashley 341

Performance analysis
A performance methodology for commercial servers — Kunkel 851

Photo-processes
Chemical amplification resists: History and development within IBM — Ito 119

Photoemission
X-ray spectro-microscopy of complex materials and surfaces — Stöhr 535

Photoresists
Chemical amplification resists: History and development within IBM — Ito 119

Physics
Contributions of IBM to laser science—1960 to the present — Sorokin 294
Holographic data storage — Ashley 341

Physics, solid state
LSI yield modeling and process monitoring — Stapper 112
Scanning tunneling microscopy — Binnig 279
Spatial variation of currents and fields due to localized scatterers in metallic conduction — Landauer 251
The future of interconnection technology — Theis 379
The future of magnetic data storage technology — Thompson 311

Programming, programs, and programming languages
Some studies in machine learning using the game of checkers — Samuel 206

Quantum theory and effects
Ab initio computations in atoms and molecules — Clementi 228

Reduced-instruction-set computers (RISC)
POWER3: The next generation of PowerPC processors — O'Connell 873
The evolution of RISC technology at IBM — Cocke 48
The 801 minicomputer — Radin 37

Scanning tunneling microscopy
Hot-electron effects and oxide degradation in MOS structures studied with ballistic electron emission microscopy — Ludeke 517
Scanning tunneling microscopy — Binnig 279

Semiconductor devices
Controlled collapse reflow chip joining — Miller 93
Design and characteristics of n-channel insulated-gate field-effect transistors — Critchlow 70
Finite-element analysis of semiconductor devices: The FIELDAY program — Buturla 142
Hot-electron effects and oxide degradation in MOS structures studied with ballistic electron emission microscopy — Ludeke 517

Semiconductor technology
Low-temperature Si and Si:Ge epitaxy by ultrahigh-vacuum/chemical vapor deposition: Process fundamentals — Meyerson 132
The future of CMOS technology — Isaac 369

Signal processing
Parallel image processing with the block data parallel architecture — Alexander 681

Silicon
The future of CMOS technology — Isaac 369

Silicon dioxide
Hot-electron effects and oxide degradation in MOS structures studied with ballistic electron emission microscopy — Ludeke 517

Solid logic technology
Solid Logic Technology: Versatile, high-performance microelectronics — Davis 56

Spectroscopy
X-ray spectro-microscopy of complex materials and surfaces — Stöhr 535

Sputtering
Application of rf discharges to sputtering — Koenig 106

Storage (computer) devices and systems
A high track-density servo-access system for magnetic recording disk storage — Hoagland 175
Holographic data storage — Ashley 341
The future of magnetic data storage technology — Thompson 311
The "Millipede"—More than one thousand tips for future AFM storage — Vettiger 323

The Random-Access Memory Accounting Machine: I. System organization of the IBM 305 — Lesser — 6
The Random-Access Memory Accounting Machine: II. The magnetic-disk, random-access memory — Noyes — 16

Surface science
Scanning tunneling microscopy — Binnig — 279

Transistors
Design and characteristics of n-channel insulated-gate field-effect transistors — Critchlow — 70
The future of CMOS technology — Isaac — 369

Transistors, bipolar
Silicon:germanium-based mixed-signal technology for optimization of wired and wireless telecommunications — Meyerson — 391

X-ray diffraction
Synchrotron X-ray scattering techniques for microelectronics-related materials studies — Jordan-Sweet — 457